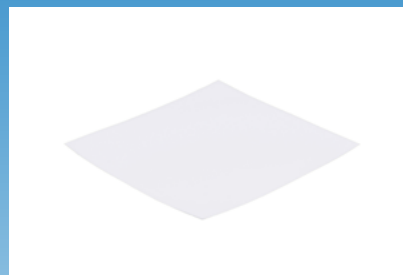


Silicone interface material

GCSP-80 is a high performance thermal interface silicone pad.

Features

- 8W/m K thermal conductivity
- Single side adhesive
- Long term stability
- Electrical insulation
- Excellent compressibility



Part number	Total thickness
GCSP-80-200x200-0.5A	0.5mm
GCSP-80-200x200-1.0A	1mm
GCSP-80-200x200-1.5A	1.5mm
GCSP-80-200x200-2.0A	2mm
GCSP-80-200x200-3.0A	3mm

Characteristic	Test Method	Value
Colour	Visual	Grey
Thickness mm	-	0.5 - 3.0
Adhesive	-	Single side
Thermal conductivity W/m*K	ASTM D5470	2.8
Thermal impedance °C-in ² /W	ASTM D5470	<0.17
Specific gravity, g/cm ³	ASTM D792	3.2
Hardness (Shore OO)	ASTM D2240	25
.5Dielectric strength, kV/mm	ASTM D149	6.0
Dielectric constant (@1kHz)	ASTM D150	5.5
Operation temperature °C	EN344	-60 ~ +200
Volume resistivity (Ohm.cm)	ASTM D257	10 ¹¹



Global Component Sourcing

E-mail: info@gcshk.net

Global component sourcing, 3705 Bank of America Tower, Suite 338,
12 Harcourt Road, Central, Hong Kong